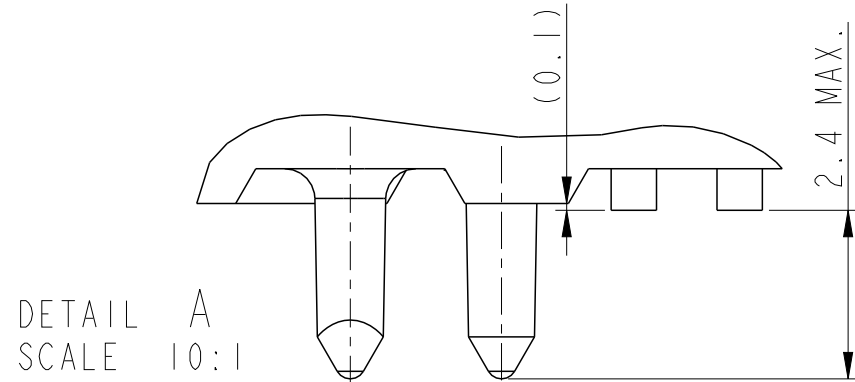
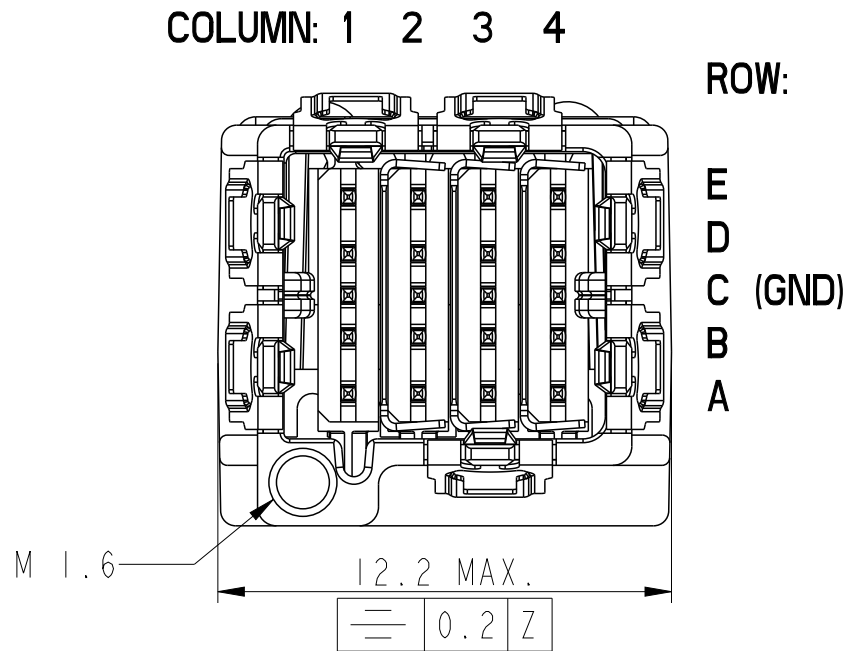
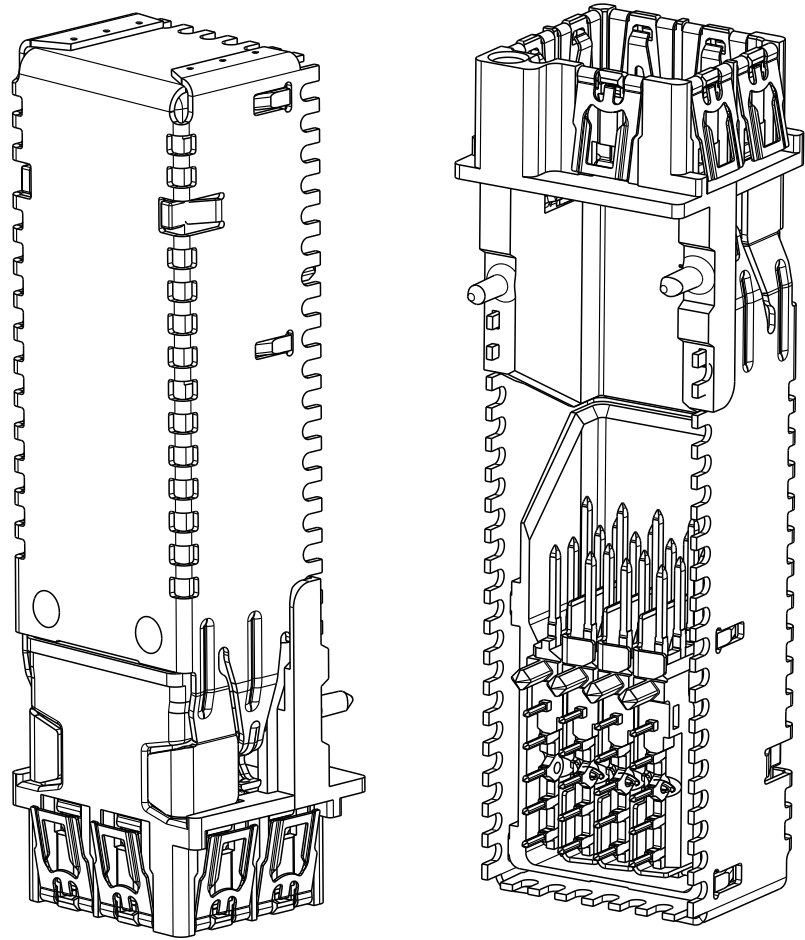
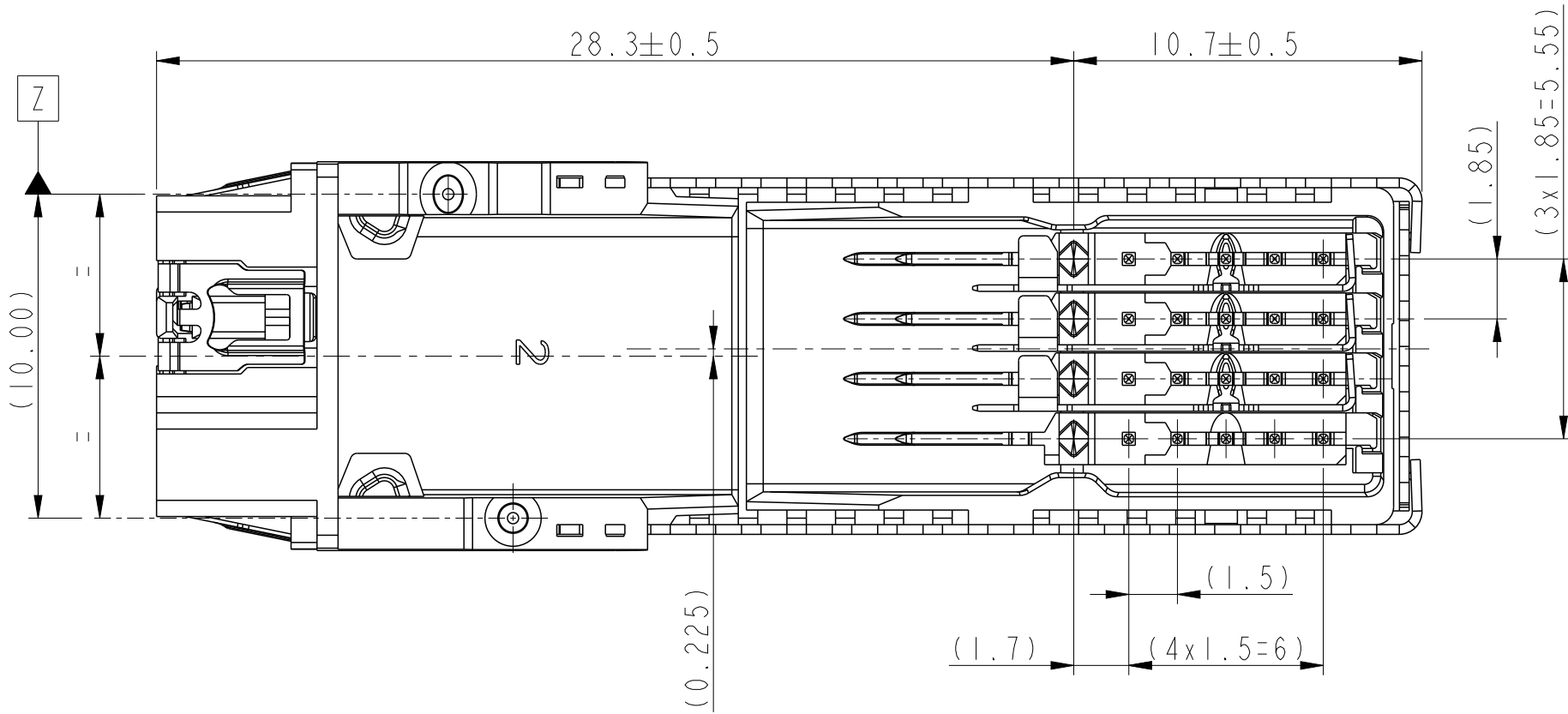
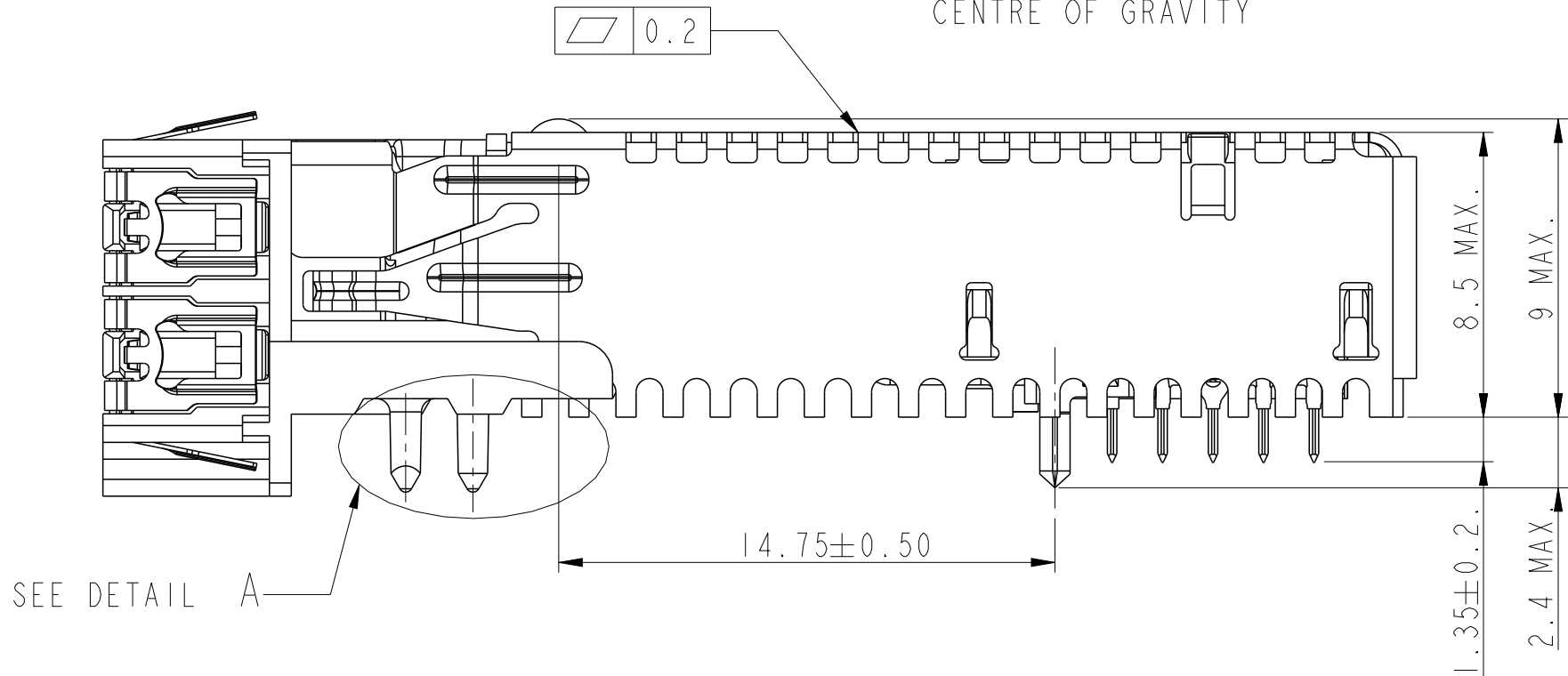
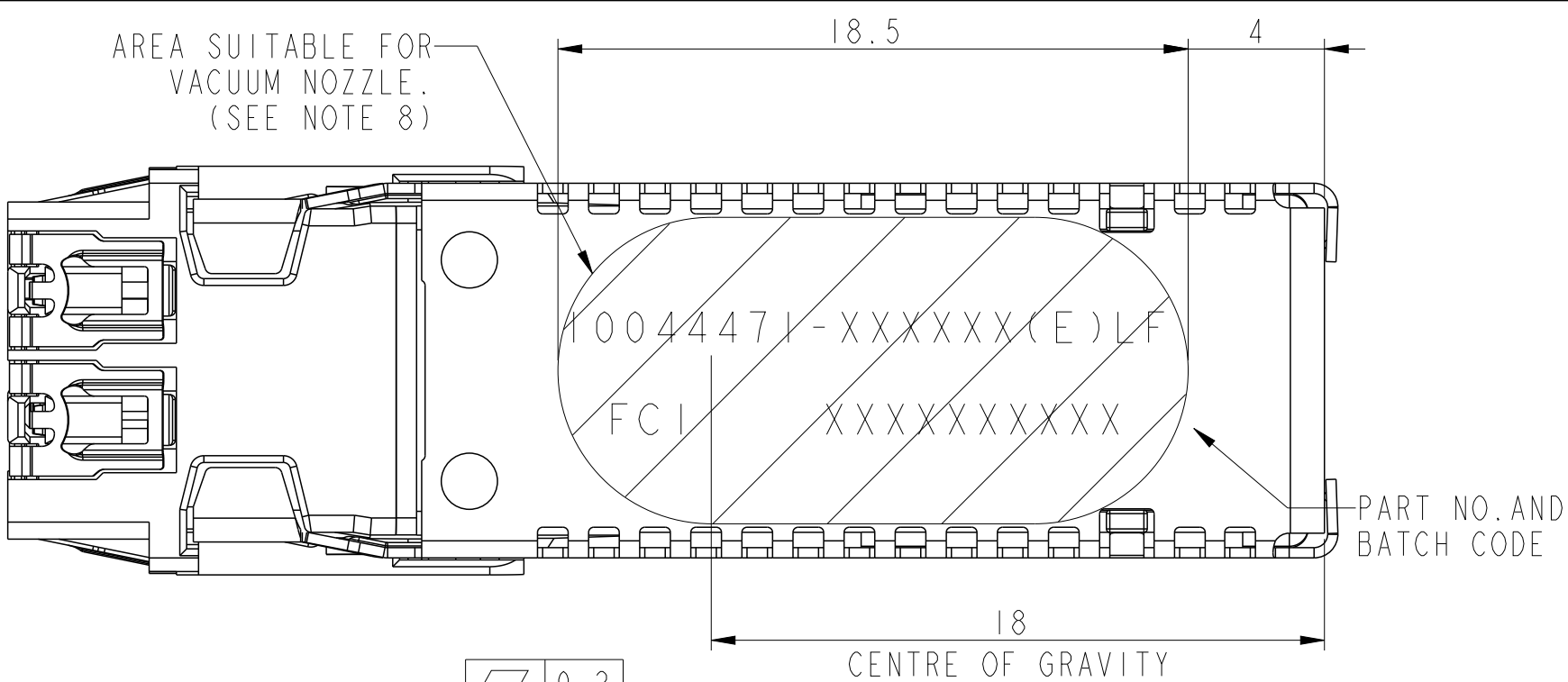


PART NUMBERING	LOADING PATTERN				PACKAGING (SEE NOTE 6)	REMARK
	COLUMN 1 (NOTE 4)	COLUMN 2	COLUMN 3	COLUMN 4		
10044471-120200LF	UNSHIELDED IMLA	EMPTY	UNSHIELDED IMLA	EMPTY	TAPE ON REEL	
10044471-122220LF	UNSHIELDED IMLA	UNSHIELDED IMLA	UNSHIELDED IMLA	UNSHIELDED IMLA	TAPE ON REEL	
10044471-121110LF	UNSHIELDED IMLA	SHIELDED IMLA	SHIELDED IMLA	SHIELDED IMLA	TAPE ON REEL	
10044471-120200ELF	UNSHIELDED IMLA	EMPTY	UNSHIELDED IMLA	EMPTY	TAPE ON REEL	CUSTOMIZED LABEL FOR SPECIAL P/NS
10044471-122220ELF	UNSHIELDED IMLA	UNSHIELDED IMLA	UNSHIELDED IMLA	UNSHIELDED IMLA	TAPE ON REEL	
10044471-121110ELF	UNSHIELDED IMLA	SHIELDED IMLA	SHIELDED IMLA	SHIELDED IMLA	TAPE ON REEL	



- NOTES:
- MATES WITH CABLE CONNECTOR 10044473-SERIES
 - MATERIALS:
DIECAST-ENTRY: ZINC ALLOY, PLATING/FINISH: Sn PLATED WITH Ni OVER Cu UNDERLAYER,
TOPCOVER - COPPER ALLOY, PLATING/FINISH: Sn PLATED WITH Ni UNDERLAYER,
SPRINGS - STAINLESS STEEL,
RETAINER - HIGH TEMPERATURE FLAME RETARDANT THERMOPLAST, COLOUR NATURAL,
VERTICAL SHIELDS - COPPER ALLOY, PLATING/FINISH: Sn WITH Ni UNDERLAYER,
HEADER IMLA'S - COPPER ALLOY OVERMOLDED WITH HIGH TEMPERATURE FLAME
RETARDANT THERMOPLAST, COLOUR BLACK,
LEADFRAME PLATING/FINISH: NICKEL UNDERPLATING, PALLADIUM-NICKEL ALLOY
WITH GOLD OVERPLATING IN CONTACT ZONE, Sn IN SOLDER TAIL AREA.
 - CONNECTOR CAN BE PICKED UP WITH A MECHANICAL GRIPPER OR A VACUUM NOZZLE,
NOZZLE DIAMETER UP TO 9 MM. ESTIMATED MAXIMUM MASS OF THE PRODUCT 6.00 G.
 - COLUMN 1 IS ALWAYS FILLED WITH AN UNSHIELDED IMLA.
 - FCI PRODUCT SPECIFICATION GS-12-314.
 - PACKAGING: TAPE AND REEL ACCORDING TO EIA-481-B, SEE LAST SHEET.
 - THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS
AS DISCRIBED IN GS-22-008.
 - THE CONNECTOR WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE
IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.FOR MORE DETAILS AND
MOUNTING RECOMMENDATIONS, SEE FCI APPLICATION GUIDE GS-20-048.



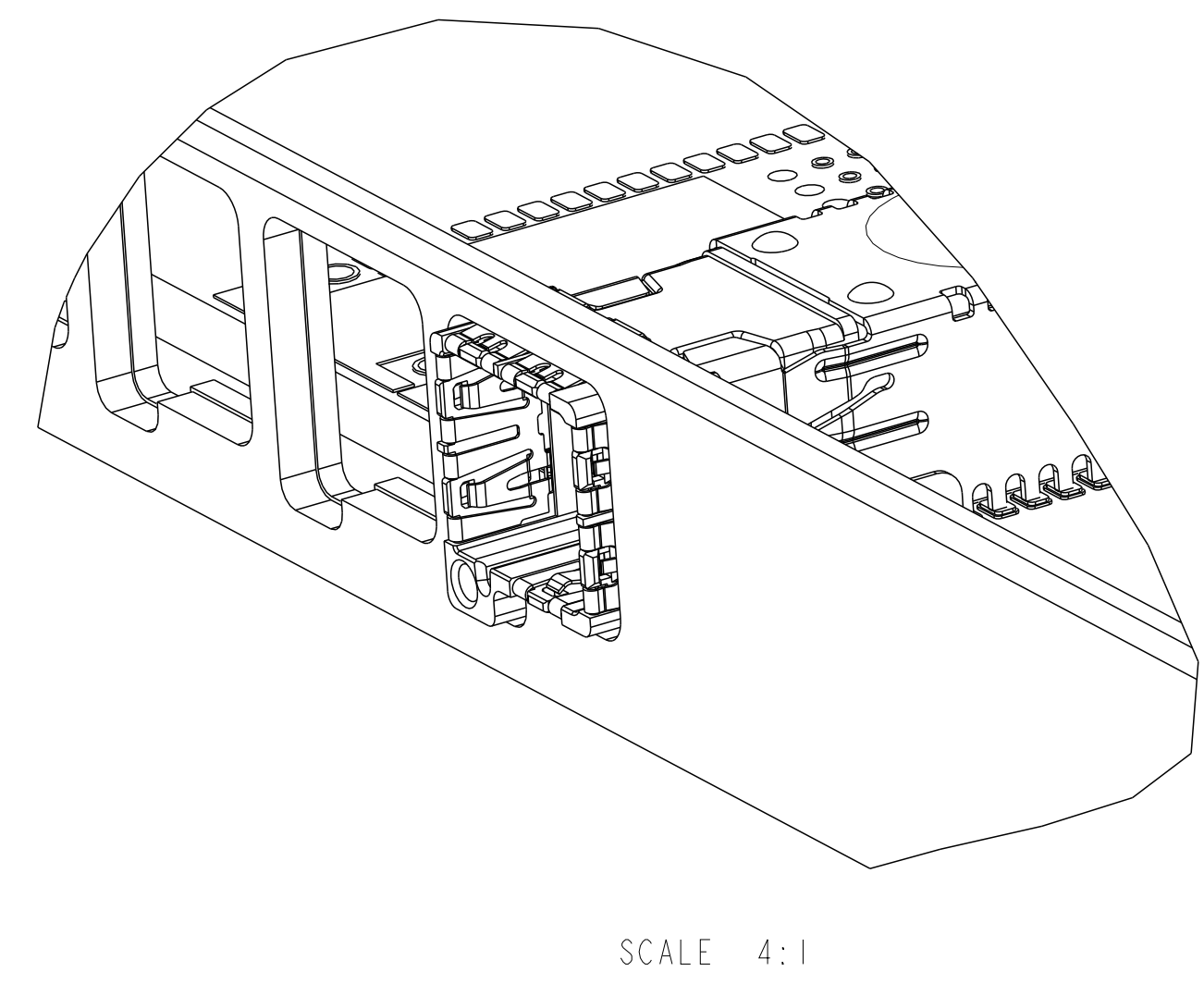
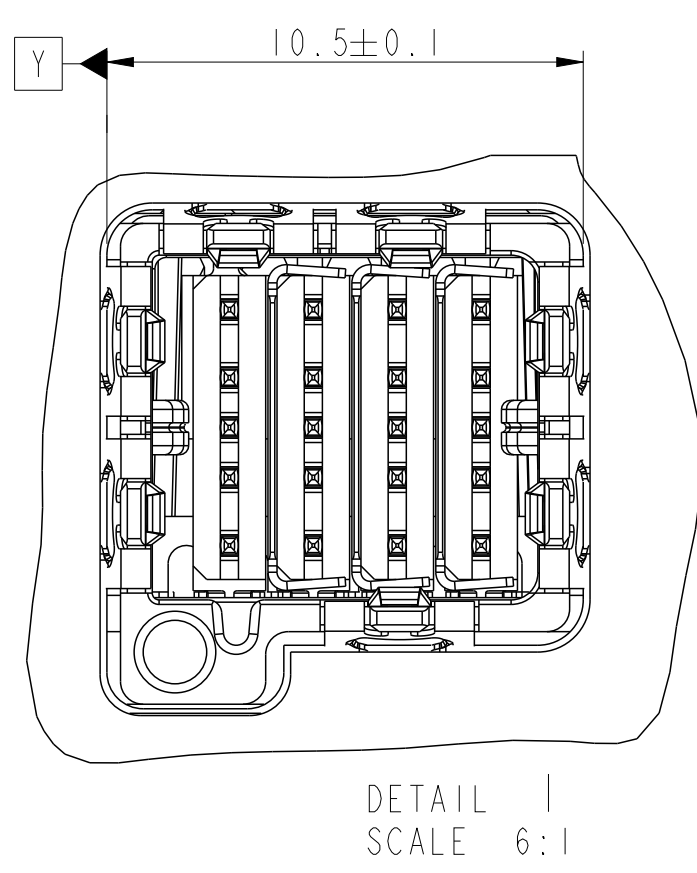
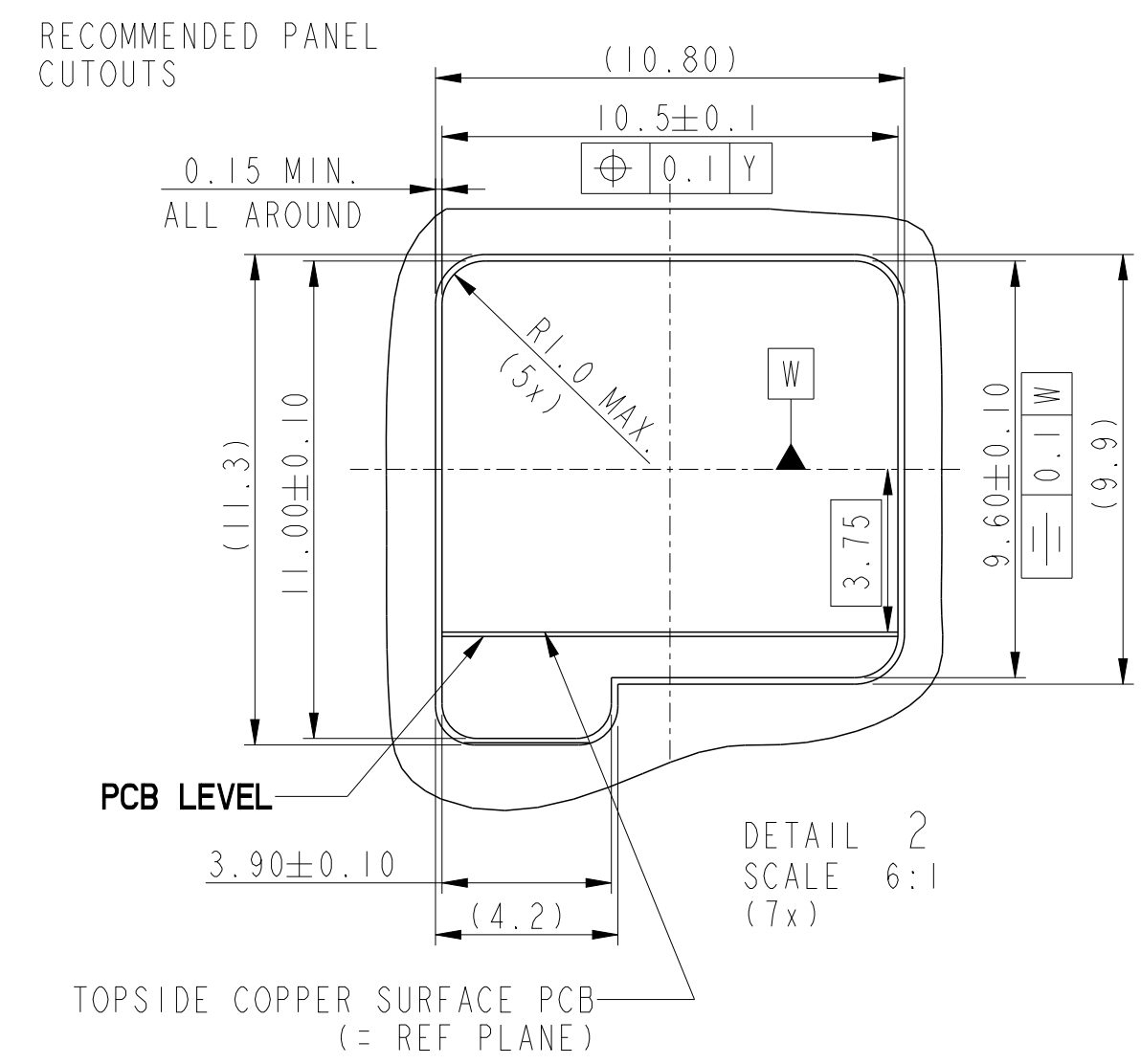
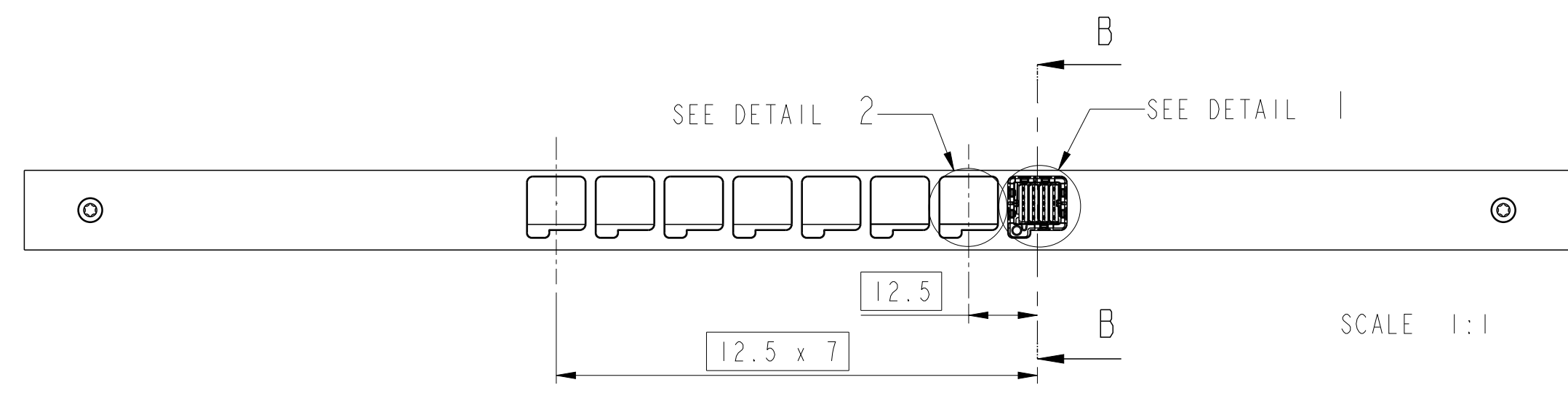
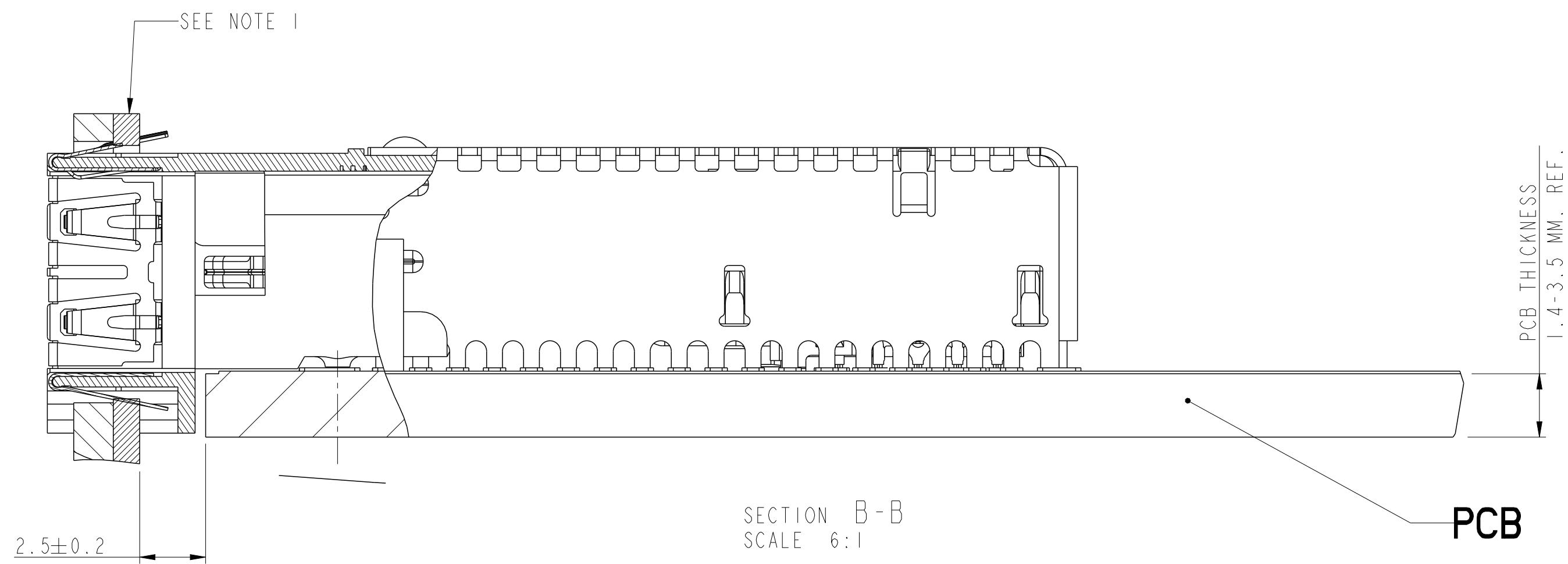
spec ref	*	dr	Terran Huang	2009/01/22	projection	mm	size	A2	scale	1:1
tolerance std	ISO 406 ISO 1101	eng	Norman Luo	2017/05/25	chr	-	ecn no	ELX-DG-27032-1	rel level	Released
surface	ISO 1302	appr	Heaven Cen	2017/05/31	product family	HEADER 8 PAIR DENS1-SHIELD I/O	cat. no.	10044471	rev	K
Product - Customer Drw										
sheet 1 of 4										

[illegible]

0.075
around,
all pads

R0.20 ± 0.01
all pads

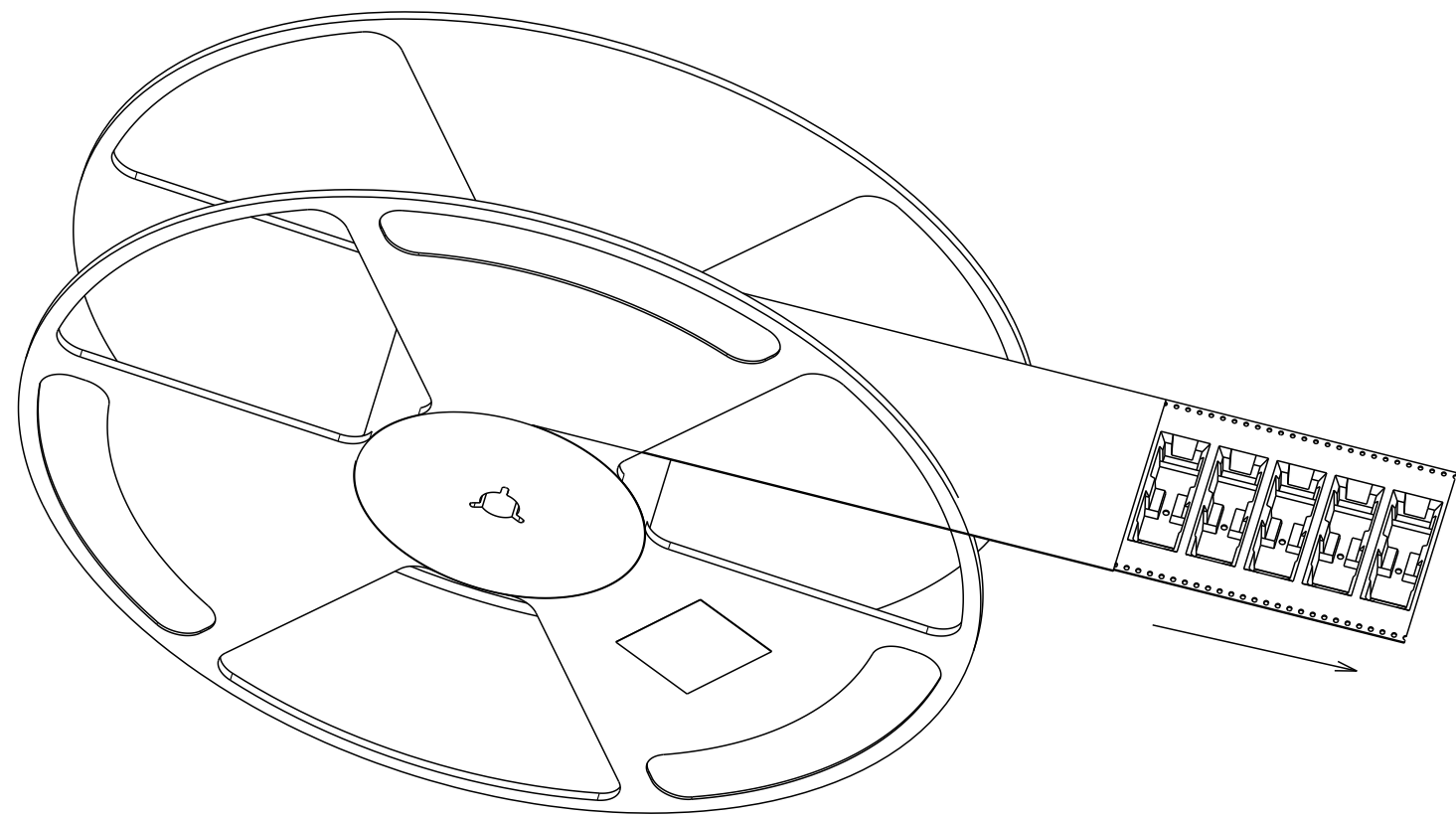
DETAIL 4
SCALE 10:1



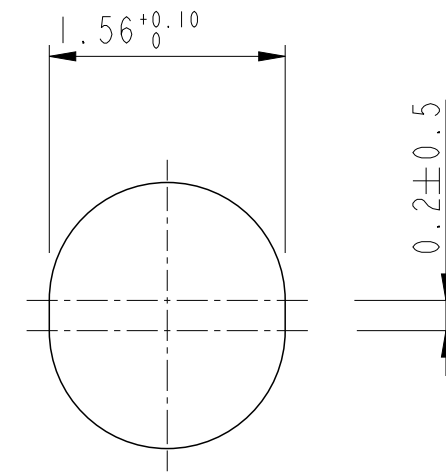
NOTE 1:
A DESIGN IS SHOWN WITH AN INNER CONDUCTIVE FRONTPANEL (FOR GROUNDING), AND A COSMETIC OUTER PANEL. THE INNER PANEL IS RECOMMENDED TO BE Sn PLATED ON THE CUTOUT EDGES.

spec ref	*	dr	Terran Huang	2009/01/22	projection	mm	size	A2	scale	6:1
tolerance std	ISO 406 ISO 1101	eng	Norman Luo	2017/05/25	chr	-	ecn no	ELX-DG-27032-1		
surface	-	appr	Heaven Cen	2017/05/31	product family	-	rel level	Released		
linear	0.X ±0.3 0.XX ±0.2 0.XXX ±0.1	Amphenol FCi	title	HEADER 8 PAIR DENSEI-SHIELD I/O	cat. no.	-	Product - Customer Drw	sheet 3 of 4	rev	K
angular	0° ±2°	www.fci.com								

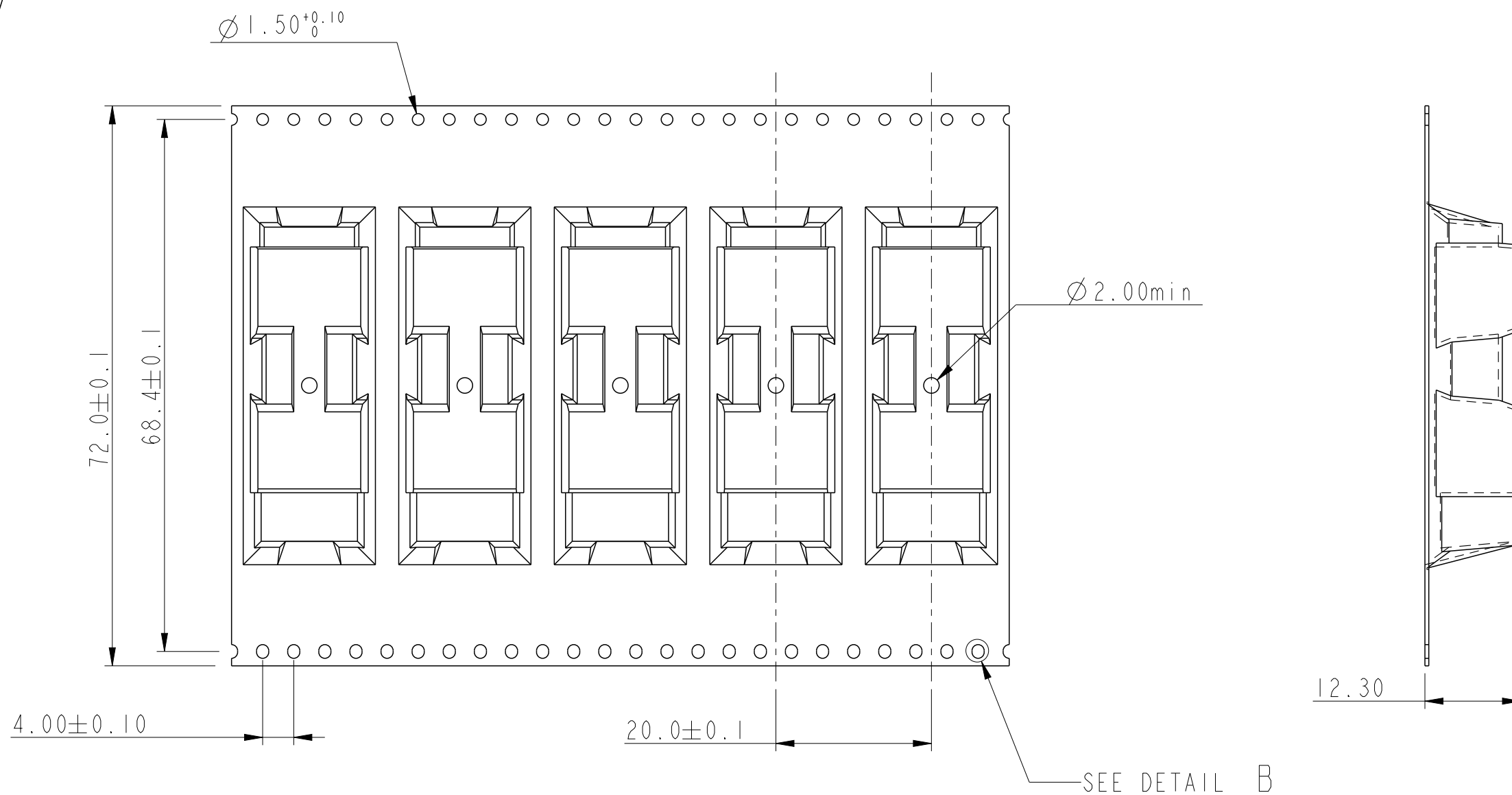
NOTE:
1:MATERIAL CARRIER TAPE: Polystyrene;
2:MATERIAL COVER TAPE : Polyester;
3:THE PACKAGING IS ANTISTATIC TREATED.



SCALE 2:5



DETAIL B
SCALE 20:1



USER DIRECTION OF FEED

spec ref	*	dr	Terran Huang	2009/01/22	projection	mm	size	A2	scale	1:6
tolerance std	ISO 406 ISO 1101	eng	Norman Luo	2017/05/25	chr	-	ecn no	ELX-DG-27032-1		
surface	ISO 1302	appr	Heaven Cen	2017/05/31	product family	-	rel level	Released		
linear	0.X ±0.3 0.XX ±0.2 0.XXX ±0.1	Amphenol FCi	title	HEADER 8 PAIR DENSEI-SHIELD I/O	cat. no.	-	Product - Customer Drw	sheet 4 of 4	rev	K
angular	0° ±2°									

PDS: Rev :K

STATUS:Released

Printed: May 31, 2017

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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